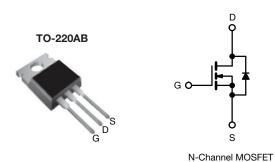
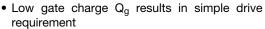


# **Power MOSFET**



PRODUCT SUMMARY						
V <sub>DS</sub> (V)	60	600				
$R_{DS(on)}(\Omega)$	$V_{GS} = 10 \text{ V}$	2.2				
Q <sub>g</sub> max. (nC)	23					
Q <sub>gs</sub> (nC)	5	5.4				
Q <sub>gd</sub> (nC)	11					
Configuration	Sin	Single				

## **FEATURES**





• Improved gate, avalanche, and dynamic dV/dt ruggedness

- · Fully characterized capacitance and avalanche voltage and current
- Effective Coss specified
- Material categorization: for definitions of compliance please see www.vishay.com/doc?99912

## Note

This datasheet provides information about parts that are RoHS-compliant and / or parts that are non RoHS-compliant. For example, parts with lead (Pb) terminations are not RoHS-compliant. Please see the information / tables in this datasheet for details

## **APPLICATIONS**

- Switch mode power supply (SMPS)
- Uninterruptable power supply
- · High speed power switching

## TYPICAL SMPS TOPOLOGY

Single Transistor flyback

ORDERING INFORMATION			
Package	TO-220AB		
Lead (Pb)-free	IRFBC30APbF		
Lead (Pb)-free and halogen-free	IRFBC30APbF-BE3		

ABSOLUTE MAXIMUM RATINGS ( $T_C$	= 25 °C, unl	ess otherwis	se noted)			
PARAMETER			SYMBOL	LIMIT	UNIT	
Drain-source voltage			$V_{DS}$	600		
Gate-source voltage			$V_{GS}$	± 30	V	
Continuous drain current	V <sub>GS</sub> at 10 V	T <sub>C</sub> = 25 °C	I <sub>D</sub>	3.6		
		$T_C = 25 ^{\circ}C$ $T_C = 100 ^{\circ}C$		2.3	Α	
Pulsed drain current <sup>a</sup>			I <sub>DM</sub>	14		
Linear derating factor				0.69	W/°C	
Single pulse avalanche energy b			E <sub>AS</sub>	290	mJ	
Repetitive avalanche current a			I <sub>AR</sub>	3.6	А	
Repetitive avalanche energy <sup>a</sup>			E <sub>AR</sub>	7.4	mJ	
Maximum power dissipation	$T_C = 1$	25 °C	$P_{D}$	74	W	
Peak diode recovery dV/dt <sup>c</sup>			dV/dt	7.0	V/ns	
Operating junction and storage temperature range			T <sub>J</sub> , T <sub>stg</sub>	-55 to +150	***	
Soldering recommendations (peak temperature) <sup>d</sup>	For 10 s		-	300	°C	
Mounting torque	6-32 or M3 screw			10	lbf ⋅ in	
				1.1	N⋅m	

- a. Repetitive rating; pulse width limited by maximum junction temperature (see fig. 11) b. Starting T<sub>J</sub> = 25 °C, L = 41 mH, R<sub>g</sub> = 25  $\Omega$ , I<sub>AS</sub> = 3.6 A (see fig. 12) c. I<sub>SD</sub>  $\leq$  3.6 A, dI/dt  $\leq$  170 A/µs, V<sub>DD</sub>  $\leq$  V<sub>DS</sub>, T<sub>J</sub>  $\leq$  150 °C

- d. 1.6 mm from case



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# Vishay Siliconix

THERMAL RESISTANCE RATINGS					
PARAMETER	SYMBOL	TYP.	MAX.	UNIT	
Maximum junction-to-ambient	R <sub>thJA</sub>	-	62		
Case-to-sink, flat, greased surface	R <sub>thCS</sub>	0.50	-	°C/W	
Maximum junction-to-case (drain)	R <sub>thJC</sub>	-	1.7		

PARAMETER	SYMBOL	TES	MIN.	TYP.	MAX.	UNIT	
Static							
Drain-source breakdown voltage	$V_{DS}$	$V_{GS} = 0 \text{ V}, I_D = 250 \mu\text{A}$		600	-	-	V
V <sub>DS</sub> temperature coefficient	$\Delta V_{DS}/T_{J}$	Referenc	e to 25 °C, I <sub>D</sub> = 1 mA	-	0.67	-	V/°C
Gate-source threshold voltage	V <sub>GS(th)</sub>	V <sub>DS</sub> =	V <sub>GS</sub> , I <sub>D</sub> = 250 μA	2.0	-	4.5	V
Gate-source leakage	I <sub>GSS</sub>	,	$V_{GS} = \pm 30 \text{ V}$	-	-	± 100	nA
		V <sub>DS</sub> =	V <sub>DS</sub> = 600 V, V <sub>GS</sub> = 0 V		-	25	
Zero gate voltage drain current	I <sub>DSS</sub>	V <sub>DS</sub> = 480 V	, V <sub>GS</sub> = 0 V, T <sub>J</sub> = 125 °C	-	-	250	μA
Drain-source on-state resistance	R <sub>DS(on)</sub>	V <sub>GS</sub> = 10 V		-	-	2.2	Ω
Forward transconductance	9 <sub>fs</sub>	V <sub>DS</sub> =	V <sub>DS</sub> = 50 V, I <sub>D</sub> = 2.2 A <sup>b</sup>		-	-	S
Dynamic		^				•	<u> </u>
Input capacitance	C <sub>iss</sub>		$V_{GS} = 0 \text{ V},$	-	510	-	
Output capacitance	C <sub>oss</sub>		$V_{GS} = 0 \text{ V},$ $V_{DS} = 25 \text{ V},$		70	-	
Reverse transfer capacitance	C <sub>rss</sub>	f = 1.0 MHz, see fig. 5		-	3.5	-	. –
Output capacitance	C <sub>oss</sub>	V <sub>GS</sub> = 0 V	V <sub>DS</sub> = 1.0 V, f = 1.0 MHz	-	730	-	pF nC
			V <sub>DS</sub> = 480 V, f = 1.0 MHz	-	19	-	
Effective output capacitance	C <sub>oss</sub> eff.	1	V <sub>DS</sub> = 0 V to 480 V <sup>c</sup>	-	31	-	
Total gate charge	Q <sub>g</sub>			-	-	23	
Gate-source charge	Q <sub>gs</sub>	V <sub>GS</sub> = 10 V	$I_D = 3.6 \text{ A}, V_{DS} = 480 \text{ V}$ see fig. 6 and 13 b	-	-	5.4	
Gate-drain charge	Q <sub>qd</sub>		see lig. 6 and 15	-	-	11	
Turn-on delay time	t <sub>d(on)</sub>			-	9.8	-	ns
Rise time	t <sub>r</sub>	V <sub>DD</sub> =	$V_{DD} = 300 \text{ V}, I_{D} = 3.6 \text{ A},$		13	-	
Turn-off delay time	t <sub>d(off)</sub>	$R_{g} = 12 \Omega$ , $R_{D} = 82 \Omega$ , see fig. 10 b		-	19	-	
Fall time	t <sub>f</sub>			-	12	-	
Gate input resistance	Rq	f = 1 MHz, open drain		0.8	-	4.6	Ω
<b>Drain-Source Body Diode Characteristic</b>					l		
Continuous source-drain diode current	Is	MOSFET symbol showing the integral reverse p - n junction diode		-	-	3.6	
Pulsed diode forward current <sup>a</sup>	I <sub>SM</sub>			-	-	14	A
Body diode voltage	$V_{SD}$	$T_J = 25  ^{\circ}\text{C},  I_S = 3.6  \text{A},  V_{GS} = 0  \text{V}^{ \text{b}}$		-	-	1.6	V
Body diode reverse recovery time	t <sub>rr</sub>	$T_{\rm J} = 25~{\rm ^{\circ}C},~I_{\rm F} = 3.6~{\rm A},~{\rm dl/dt} = 100~{\rm A/\mu s}~{\rm ^{b}}$		-	400	600	ns
Body diode reverse recovery charge	Q <sub>rr</sub>			-	1.1	1.7	μC
Forward turn-on time	t <sub>on</sub>	Intrinsic tu	rn-on time is negligible (turn	on is do	minated b	ov Le and	[ D)

# Notes

- a. Repetitive rating; pulse width limited by maximum junction temperature (see fig. 11)
- b. Pulse width  $\leq 300~\mu s;$  duty cycle  $\leq 2~\%$
- c.  $C_{oss}$  eff. is a fixed capacitance that gives the same charging time as  $C_{oss}$  while  $V_{DS}$  is rising from 0 % to 80 %  $V_{DS}$



# TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)

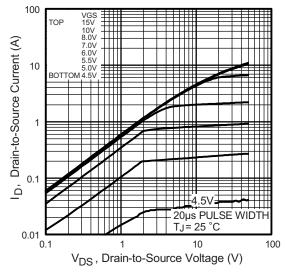


Fig. 1 - Typical Output Characteristics

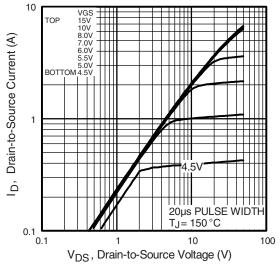


Fig. 2 - Typical Output Characteristics

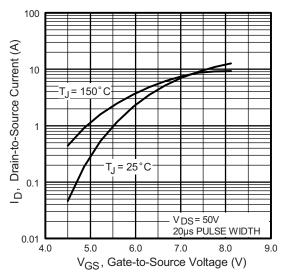


Fig. 3 - Typical Transfer Characteristics

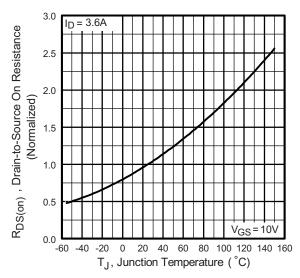


Fig. 4 - Normalized On-Resistance vs. Temperature



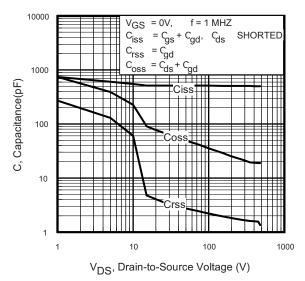


Fig. 5 - Typical Capacitance vs. Drain-to-Source Voltage

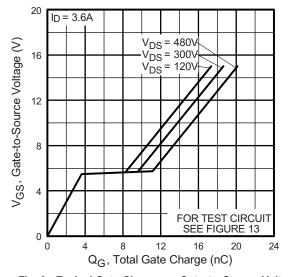


Fig. 6 - Typical Gate Charge vs. Gate-to-Source Voltage

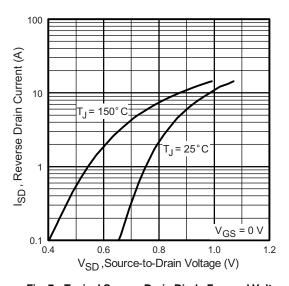


Fig. 7 - Typical Source-Drain Diode Forward Voltage

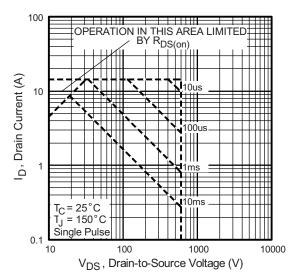


Fig. 8 - Maximum Safe Operating Area



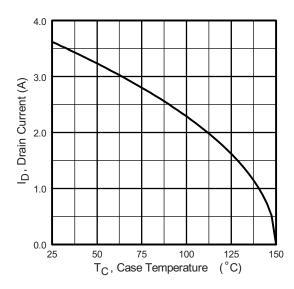


Fig. 9 - Maximum Drain Current vs. Case Temperature

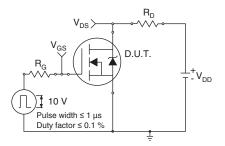


Fig. 10a - Switching Time Test Circuit

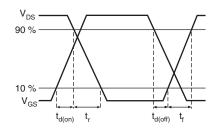


Fig. 10b - Switching Time Waveforms

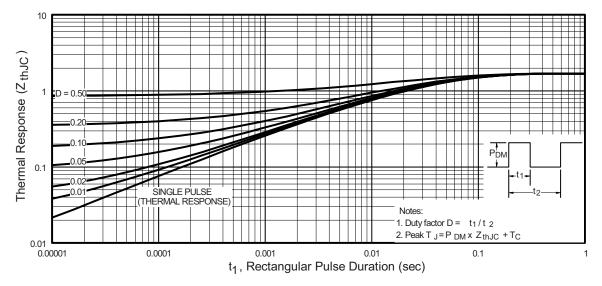


Fig. 11 - Maximum Effective Transient Thermal Impedance, Junction-to-Case

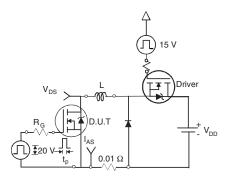


Fig. 12a - Unclamped Inductive Test Circuit

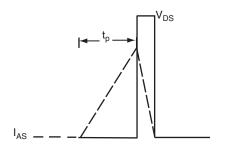


Fig. 12b - Unclamped Inductive Waveforms



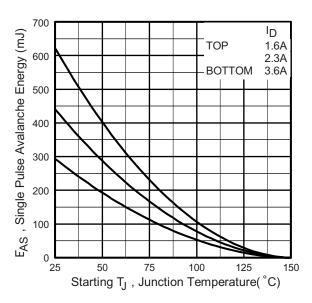


Fig. 12c - Maximum Avalanche Energy vs. Drain Current

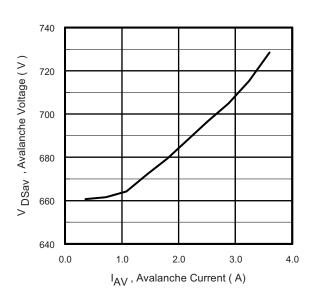


Fig. 12d - Typical Drain-to-Source Voltage vs.
Avalanche Current

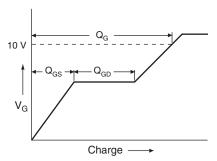


Fig. 13a - Basic Gate Charge Waveform

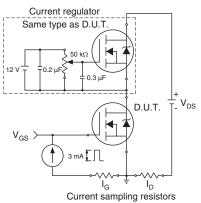
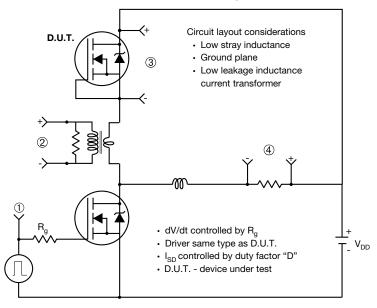


Fig. 13b - Gate Charge Test Circuit



## Peak Diode Recovery dV/dt Test Circuit



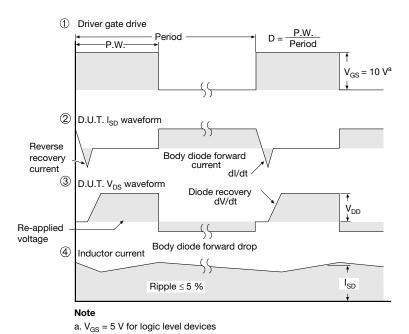


Fig. 14 - For N-Channel

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